Unit in mm

TOSHIBA Transistor Silicon NPN Epitaxial Type (PCT Process)

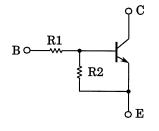
## RN1101FV, RN1102FV, RN1103FV RN1104FV, RN1105FV, RN1106FV

Switching, Inverter Circuit, Interface Circuit and Driver Circuit Applications

- Ultra-small package, suited to very high density mounting
- Incorporating bias resistance into the transistor reduces the number of parts, so enabling the manufacture of ever more compact equipment and lowering assembly cost.
- A wide range of resistor values is available for use in various circuits.
- Complementary to RN2101FV~RN2106FV

### $1.2 \pm 0.05$ ± 0.05 $0.80 \pm 0.05$ $0.32 \pm 0.05$ 23 $1.2 \pm 0.05$ $0.8 \pm 0.0$ 3 13 ± 0.05 0.05 1.BASE 2.EMITTER VESM 3.COLLECTOR JEDEC JEITA \_\_\_\_ 2-1L1A TOSHIBA Weight: 0.0015 g(typ.)

#### **Equivalent Circuit and Bias Resister Values**

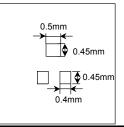


Type No.	R1 (kΩ)	R2 (kΩ)
RN1101FV	4.7	4.7
RN1102FV	10	10
RN1103FV	22	22
RN1104FV	47	47
RN1105FV	2.2	47
RN1106FV	4.7	47

Maximum Ratings (Ta = 25°C)

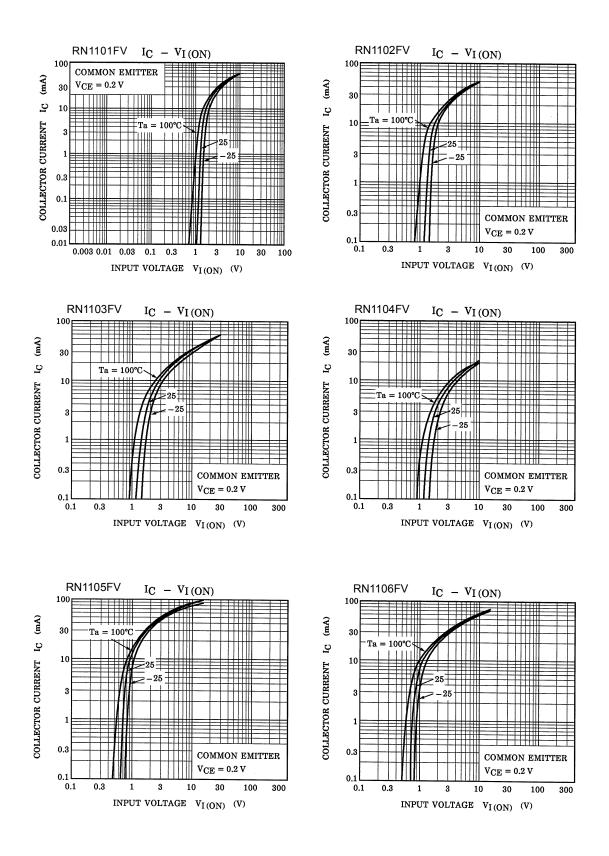
Characteristic		Symbol	Rating	Unit	
Collector-base voltage	RN1101EV~1106EV	V <sub>CBO</sub>	50	V	
Collector-emitter voltage		V <sub>CEO</sub>	50	V	
Emitter-base voltage	RN1101FV~1104FV	V <sub>EBO</sub>	10	V	
	RN1105FV, 1106FV	▲EBO	5		
Collector current		۱ <sub>C</sub>	100	mA	
Collector power dissipation	RN1101EV~1106EV	P <sub>C</sub> (Note)	150	mW	
Junction temperature		Тj	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

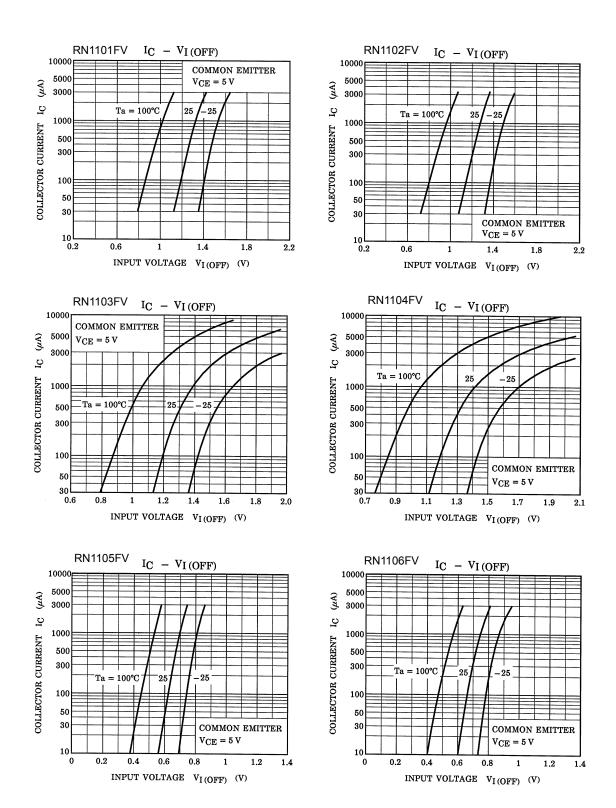
Note : Mounted on FR4 board (25.4 mm  $\times$  25.4 mm  $\times$  1.6mmt)

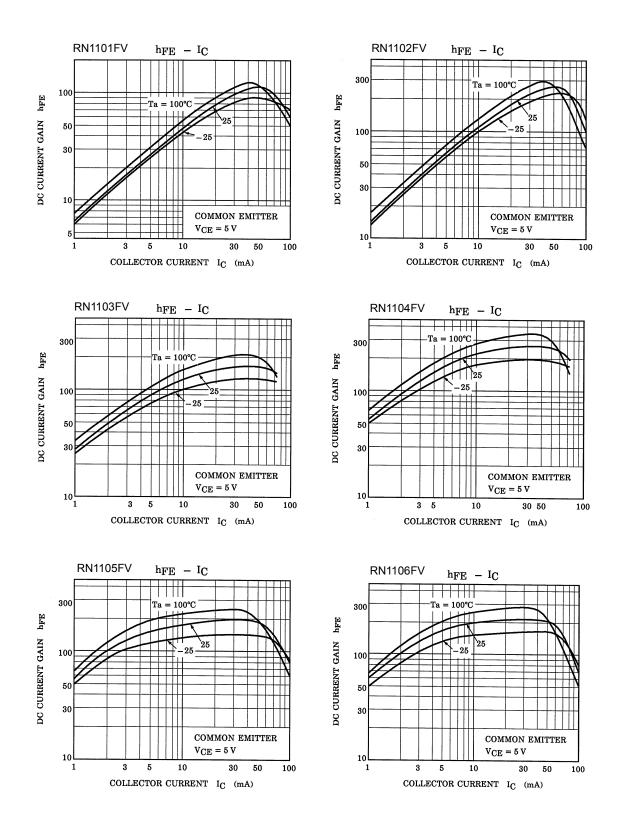


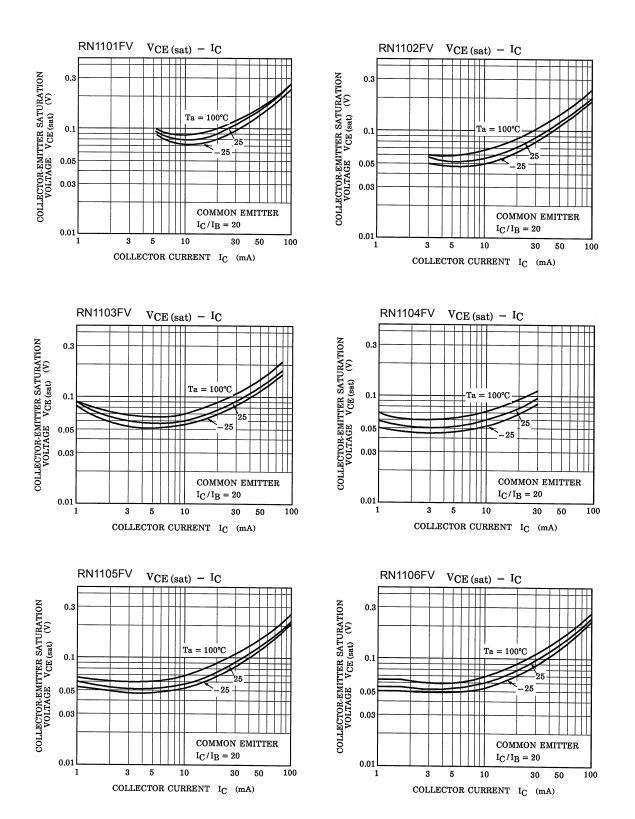
# Electrical Characteristics (Ta = 25°C)

Charact	teristic	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Collector cut-off current	RN1101FV~1106FV	I <sub>CBO</sub>		$V_{CB} = 50V, I_E = 0$	_	_	100	nA
		ICEO	_	V <sub>CE</sub> = 50V, I <sub>B</sub> = 0	_	_	500	ПА
Emitter cut-off current	RN1101FV	I <sub>EBO</sub>	_	V <sub>EB</sub> = 10V, I <sub>C</sub> = 0	0.82	—	1.52	mA
	RN1102FV				0.38	—	0.71	
	RN1103FV				0.17	—	0.33	
	RN1104FV				0.082	_	0.15	
	RN1105FV				0.078	_	0.145	
	RN1106FV			V <sub>EB</sub> = 5V, I <sub>C</sub> = 0	0.074	_	0.138	
	RN1101FV				30	_	—	
	RN1102FV				50	—	—	
DC current gain	RN1103FV	b		V <sub>CE</sub> = 5V, I <sub>C</sub> = 10mA	70	_	_	
	RN1104FV	h <sub>FE</sub>		$v_{CE} = 5v, i_C = 1000A$	80	_	_	
	RN1105FV				80	—	—	
	RN1106FV				80	_	_	
Collector-emitter saturation voltage	RN1101FV~1106FV	V <sub>CE (sat)</sub>	_	I <sub>C</sub> = 5mA, I <sub>B</sub> = 0.25mA	-	0.1	0.3	V
	RN1101FV	V <sub>I (ON)</sub>	_	V <sub>CE</sub> = 0.2V, I <sub>C</sub> = 5mA	1.1	—	2.0	V
	RN1102FV				1.2	_	2.4	
Input voltage (ON)	RN1103FV				1.3	_	3.0	
Input voltage (ON)	RN1104FV				1.5	_	5.0	
	RN1105FV				0.6	_	1.1	
	RN1106FV				0.7	_	1.3	
	RN1101FV~1104FV	V <sub>I (OFF)</sub>	_	V <sub>CE</sub> = 5V, I <sub>C</sub> = 0.1mA	1.0	_	1.5	V
Input voltage (OFF)	RN1105FV, 1106FV				0.5	_	0.8	V
Transition frequency	RN1101FV~1106FV	f <sub>T</sub>	—	V <sub>CE</sub> = 10V, I <sub>C</sub> = 5mA		250	—	$MH_Z$
Collector output capacitance	RN1101FV~1106FV	C <sub>ob</sub>	—	$V_{CB} = 10V, I_E = 0, f = 1MH_z$		3	—	pF
	RN1101FV	R1	_	_	3.29	4.7	6.11	kΩ
	RN1102FV				7	10	13	
Input resistor	RN1103FV				15.4	22	28.6	
	RN1104FV				32.9	47	61.1	
	RN1105FV				1.54	2.2	2.86	
	RN1106FV				3.29	4.7	6.11	
Resistor ratio	RN1101FV~1104FV		_	_	0.9	1.0	1.1	
	RN1105FV	R1/R2			0.0421	0.0468	0.0515	
	RN1106FV				0.09	0.1	0.11	









# **TOSHIBA**

Type Name	Marking
RN1101FV	Type Name XA
RN1102FV	Type Name XB
RN1103FV	Type Name
RN1104FV	Type Name XD
RN1105FV	Type Name XE
RN1106FV	Type Name XF

#### **RESTRICTIONS ON PRODUCT USE**

030619EAA

- The information contained herein is subject to change without notice.
- The information contained herein is presented only as a guide for the applications of our products. No responsibility is assumed by TOSHIBA for any infringements of patents or other rights of the third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of TOSHIBA or others.
- TOSHIBA is continually working to improve the quality and reliability of its products. Nevertheless, semiconductor devices in general can malfunction or fail due to their inherent electrical sensitivity and vulnerability to physical stress. It is the responsibility of the buyer, when utilizing TOSHIBA products, to comply with the standards of safety in making a safe design for the entire system, and to avoid situations in which a malfunction or failure of such TOSHIBA products could cause loss of human life, bodily injury or damage to property.
  In developing your designs, please ensure that TOSHIBA products are used within specified operating ranges as

set forth in the most recent TOSHIBA products specifications. Also, please keep in mind the precautions and conditions set forth in the "Handling Guide for Semiconductor Devices," or "TOSHIBA Semiconductor Reliability Handbook" etc..

- The TOSHIBA products listed in this document are intended for usage in general electronics applications (computer, personal equipment, office equipment, measuring equipment, industrial robotics, domestic appliances, etc.). These TOSHIBA products are neither intended nor warranted for usage in equipment that requires extraordinarily high quality and/or reliability or a malfunction or failure of which may cause loss of human life or bodily injury ("Unintended Usage"). Unintended Usage include atomic energy control instruments, airplane or spaceship instruments, transportation instruments, traffic signal instruments, combustion control instruments, medical instruments, all types of safety devices, etc.. Unintended Usage of TOSHIBA products listed in this document shall be made at the customer's own risk.
- TOSHIBA products should not be embedded to the downstream products which are prohibited to be produced and sold, under any law and regulations.